1st Round Announcement and CALL for Papers and Extended Abstracts

2018 INTERNATIONAL SEMINAR ON ADVANCED MATERIALS RESEARCH

2018 ISAMR

Sponsored by

China Materials Research Society

Beijing Institute of Technology

Donghua University

Science and Technology on Applied Physical

Chemical Laboratory









Shanghai, China August 2–5, 2018

(Registration Date: August 2)

Welcome to 2018 ISAMR

Two years ago, 2016 International Seminar on Advanced Materials Research (2016 ISAMR) was successfully held at Kunming Wenhui Hotel in Kunming, Yunnan Province, China, October, 14-16, 2016. 330 people attended the seminar and 135 speeches were made by scholars from more than ten countries. During the seminar, there are plenary session and eight parallel sessions including nano photonic materials, biomedical materials, advanced composite materials, advanced fiber and functional textile materials, new energy materials, environment-friendly materials and two special sessions honoring Academician Prof. Mai Yiu-Wing and Academician Prof. Huang Wei.

2018 International Seminar on Advanced Materials Research (2018 ISAMR) will be held in Shanghai on August 2-5, 2018, China (hotel to be decided). 2018 ISAMR is not only a continuation, but also an extension of 2016 ISAMR. This series seminars are scheduled to be held every two years in China with topics of stimulating discussions on the forefront research in material science and technology.

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Main Topics

Nano Photonic Materials; Organic Semiconductor
Materials; Functional Biomaterials; Biomedical Materials;
Advanced Composite Materials; Advanced Fiber and
Functional Textile Materials; Energy Materials; High
Energy Materials; Environmental-friendly Materials; 3D
Printing; Materials under Dynamic and Extreme Loading
Conditions; High-entropy Alloy; Photocatalytic Materials.

Conference Language

The conference language is English, which will be used for all presentations and printed materials.

Submission of Papers and Extended Abstracts

The seminar accept papers and extended abstracts, which must be submitted by website http://ISAMR.bit.edu.cn NO LATER THAN May 10, 2018. The instructions for extended abstracts can be found on the website.

The author is also welcome to state his preference for oral or poster session, though both forms of delivery will be included in the Proceedings of 2018 ISAMR.

Website

For up-to-date information on the seminar, please visit the website http://ISAMR.bit.edu.cn.

Important Dates

May 10, 2018

Final date for submission of extended abstracts

May 20, 2018

Authors notified of extended abstracts acceptance

June 20, 2018

Final Announcement with list of extended abstracts

August 2, 2018

Registration

August 3-5, 2018

2018 ISAMR

Registration Fee

The registration fee is US\$500, including one copy of the proceedings of the seminar, banquet, meals, coffee breaks. The fee for student is US\$300, including the proceedings of the seminar, meals, coffee breaks, and for companion is US\$300, including banquet, meals and shopping guide. Special functions require additional fees. The registration fee will be reduced to US\$400 and US\$250 respectively, if payed before July 10.

Secretariat

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